

# **Product Change Notification - LIAL-30DTSS543**

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03	Feb	2020

**Product Category:** 

Memory

**Affected CPNs:** 



Data:

### **Notification subject:**

Memo # ML01202000QB: Final Notice: New silicon mask set with design and layout changes for selected Microchip products of the AT24C16D device family.

**Notification text:** 

### **PCN Status:**

Final notification.

# PCN Type:

Manufacturing Change

# **Microchip Parts Affected:**

Please open one of the icons found in the Affected CPNs section above.

**NOTE:** For your convenience Microchip includes identical files in two formats (.pdf and .xls)

# **Description of Change:**

New silicon mask set with design and layout changes for selected Microchip products of the AT24C16D device family

#### Pre Change:

Manufactured using 36316 Rev A0 mask on 36.3K wafer technology fabricated at Microchip fabrication sites FAB 5 (Colorado Springs, CO, USA) using 6 inch wafers.

# **Post Change:**

Manufactured using 363V4 rev A2 mask on 36.3K wafer technology fabricated at Microchip fabrication site FAB 5 (Colorado Springs, CO, USA) using 6 inch wafers or manufactured using 36316 Rev A0 mask on 36.3K wafer technology fabricated at Microchip fabrication site FAB 5 (Colorado Springs, CO, USA) using 6 inch wafers.

Pre and Post Change Summary:

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	Pre Change	Post Change							
Wafer Mask	36316 Rev A0	363V4 Rev A2	36316 Rev A0						
Wafer Technology	36.3K wafer technology	36.3K wafer technology							
Fabrication Location	FAB 5 (Colorado Springs, CO USA)	FAB 5 (Colorado Springs, CO USA)							
Wafer Diameter	6 inches (150 mm)	6 inches (150 mm)							
Quality certification	ISO/TS16949	ISO9001/TS16949							



### Impacts to Data Sheet:

None

# **Change Impact:**

None

### **Reason for Change:**

to improve manufacturability by qualifying a new silicon mask set with design and layout changes.

### **Change Implementation Status:**

In Progress

# **Estimated First Ship Date:**

April 15, 2020 (date code: 2016)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts

# **Time Table Summary:**

	February 2020				->	April 2020				
Workweek	06	07	08	09		14	15	16	17	18
Final PCN Issue Date	Х									
Qual Report Availability	Х									
Estimated Implementation								V		
Date								^		

# Method to Identify Change:

Traceability code

# **Qualification Report:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual Report.

# **Revision History:**

**February 3, 2020:** Issued final notification. Attached the qualification report. Provided estimated first ship date to be on April 15, 2020

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products

#### Attachment(s):

PCN LIAL-30DTSS543 QUAL REPORT.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

#### **Terms and Conditions:**

If you wish to receive Microchip PCNs via email please register for our PCN email service at our



<u>PCN home page</u> select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

AT24C16D-MAHM-E

AT24C16D-MAHM-T

AT24C16D-PUM

AT24C16D-SSHM-B

AT24C16D-SSHM-T

AT24C16D-STUM-T

AT24C16D-XHM-B

AT24C16D-XHM-T

Date: Sunday, February 02, 2020